

TIBTRONIX TECHNOLOGY CO., LTD.



TXBLXG60-23/32

10Gb/s 60km BiDi XFP Transceiver
Hot Pluggable, Single LC, 1270/1330nm, CWDM DFB&APD, Single mode

2015/3/9



Shenzhen Tibtronix Technology Co., Ltd.

3/F, 12th Building, Nangang 1st Industrial Park, Baimang Xili, Songbai Road, Nanshan District, Shenzhen, China

Tel: +86 755 23316583

Fax: +86 755 29810056

E-mail: sales@tibtronix.com

<http://www.tibtronix.com>

Features:

- ✧ Supports 9.95Gb/s to 11.3Gb/s bit rates
- ✧ Hot-pluggable XFP footprint
- ✧ Single LC for Bi-directional Transmission
- ✧ Maximum link length of 60km
- ✧ Built-in 1270/1330 WDM
- ✧ Uncooled 1270nm or 1330nm CWDM DFB Laser
- ✧ APD Receiver
- ✧ Power dissipation <2W
- ✧ No Reference Clock required
- ✧ Built-in digital diagnostic functions
- ✧ Temperature range 0°C to 70°C
- ✧ Very low EMI and excellent ESD protection
- ✧ RoHS Compliant Part

Applications:

- ✧ 10GBASE-LR/LW Ethernet
- ✧ SONET OC-192 /SDH
- ✧ 1200-SM-LL-L 10G Fibre Channel

Description:

TIBTRONIX' TXBLXG60-23/32 Bi-directional 10Gb/s (XFP) transceivers are compliant with the current XFP Multi-Source Agreement (MSA) Specification. They comply with 10-Gigabit Ethernet 10GBASE-LR/LW per IEEE 802.3ae and 10G Fibre Channel 1200-SM-LL-L. Digital diagnostics functions are available via a 2-wire serial interface, as specified in the XFP MSA.

● Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Storage Temperature	T_{ST}	-40	+85	°C
Case Operating Temperature	T_{IP}	0	+70	°C
Supply Voltage	V_{CC3}	-0.5	+4.0	V

● Electrical Characteristics ($T_{OP} = 0$ to 70 °C)

Parameter	Symbol	Min	Typ	Max	Unit	Note	
Supply Voltage	V_{CC3}	3.13		3.45	V		
Supply Current	I_{CC3}			500	mA		
Module total power	P			2	W		
Transmitter							
Input differential impedance	R_{in}		100		Ω	1	
Differential data input swing	$V_{in,pp}$	150		820	mV		
Transmit Disable Voltage	V_D	2.0		V_{CC}	V		
Transmit Enable Voltage	V_{EN}	GND		GND+ 0.8	V		
Transmit Disable Assert Time	T_{off}			100	ms		
Tx Enable Assert Time	T_{on}			100	ms		
Receiver							
Differential data output swing	$V_{out,pp}$	300	500	850	mV		
Data output rise time	t_r			35	ps	2	
Data output fall time	t_f			35	ps	2	
LOS Fault	$V_{LOS\ fault}$	$V_{CC} - 0.5$		$V_{CC_{HOST}}$	V	3	
LOS Normal	$V_{LOS\ norm}$	GND		GND+0.5	V	3	
Power Supply Rejection	PSR	See Note 4 below					4

Notes

1. After internal AC coupling.
2. 20 – 80 %
3. Loss of Signal is open collector to be pulled up with a 4.7k – 10kohm resistor to 3.15 – 3.6V. Logic 0 indicates normal operation; logic 1 indicates no signal detected.
4. Per Section 2.7.1. in the XFP MSA Specification.

● Optical Parameters($T_{OP} = 0$ to $70^{\circ}C$)

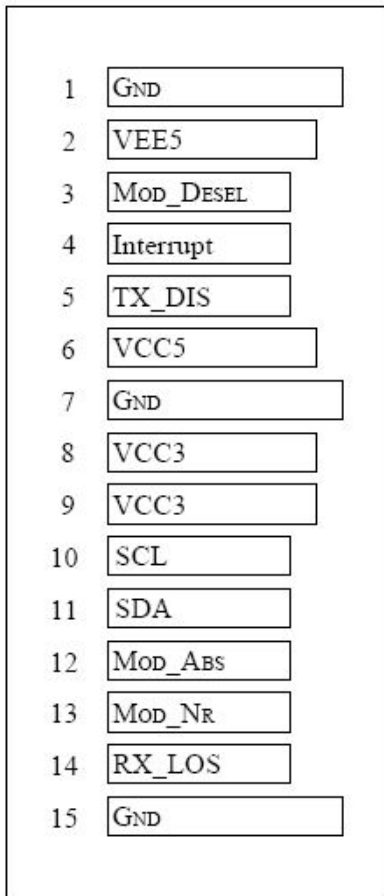
Parameter		Symbol	Min	Typ	Max	Unit	Ref.	
Transmitter								
Operating Date Rate		BR	9.95		11.3	Gb/s		
Bit Error Rate		BER			10^{-12}			
Maximum Launch Power		P_{MAX}	0		+5	dBm	1	
Optical Center Wavelength	FTP960-2733	λ	1260	1270	1280	nm		
	FTP960-3327		1320	1330	1340			
Optical Extinction Ratio		ER	3.5			dB		
Spectral Width		$\Delta\lambda$			1	nm		
Sidemode Supression ratio		SSRmin	30			dB		
Rise/Fall Time (20%~80%)		Tr/Tf			50	ps		
Average Launch power of OFF Transmitter		P_{OFF}			-30	dBm		
Tx Jitter		Txj	Compliant with each standard requirements					
Optical Eye Mask			IEEE802.3ae					2
Receiver								
Operating Date Rate		BR	9.95		11.3	Gb/s		
Receiver Sensitivity		Sen			-22	dBm	2	
Maximum Input Power		P_{MAX}	-7			dBm	2	
Optical Center Wavelength	FTP960-2733	λ_c	1320	1330	1340	nm		
	FTP960-3327		1260	1270	1280			
Receiver Reflectance		Rrx			-27	dB		
LOS De-Assert		LOS _D			-23	dBm		
LOS Assert		LOS _A	-33			dBm		
LOS Hysteresis		LOS _H	0.5		5	dB		

Notes:

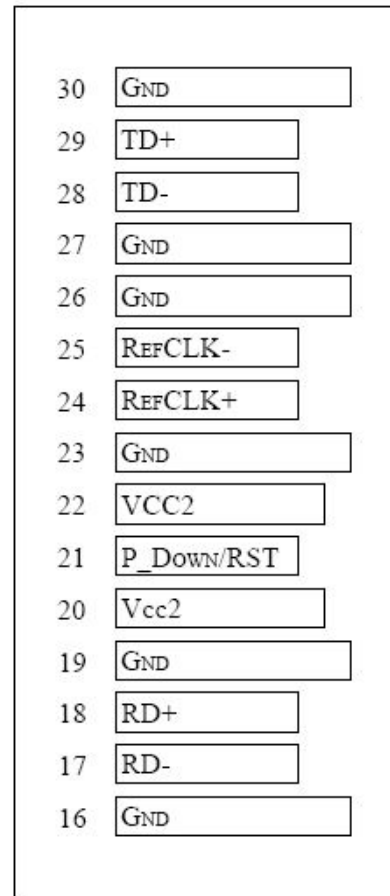
1. The optical power is launched into SMF.
2. Measured with a PRBS $2^{31}-1$ test pattern @10.3125Gbps BER< 10^{-12} .

● Pin Assignment

Diagram of Host Board Connector Block Pin Numbers and Name



Bottom of Board
(As view through top of board)



Top of Board

● Pin Function Definitions

Pin	Logic	Symbol	Name/Description	Ref.
1		GND	Module Ground	1
2		VEE5	Optional -5.2 Power Supply – Not required	
3	LVTTL-I	Mod-Desel	Module De-select; When held low allows the module to respond to 2-wire serial interface commands	
4	LVTTL-O	Interrupt	Interrupt (bar); Indicates presence of an important condition which can be read over the serial 2-wire interface	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off	
6		VCC5	+5 Power Supply	
7		GND	Module Ground	1

8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTTL-I	SCL	Serial 2-wire interface clock	2
11	LVTTTL-I/O	SDA	Serial 2-wire interface data line	2
12	LVTTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2
13	LVTTTL-O	Mod_NR	Module Not Ready;	2
14	LVTTTL-O	RX_LOS	Receiver Loss of Signal indicator	2
15		GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RD-	Receiver inverted data output	
18	CML-O	RD+	Receiver non-inverted data output	
19		GND	Module Ground	1
20		VCC2	+1.8V Power Supply – Not required	
21	LVTTTL-I	P_Down/RS T	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset	
			Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.	
22		VCC2	+1.8V Power Supply – Not required	
23		GND	Module Ground	1
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board – Not required	3
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host board – Not required	3
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Module Ground	1

Note

1. Module circuit ground is isolated from module chassis ground within the module.
2. Open collector; should be pulled up with 4.7k – 10k ohms on host board to a voltage between 3.15V and 3.45V.
3. A Reference Clock input is not required.

● Digital Diagnostic Functions

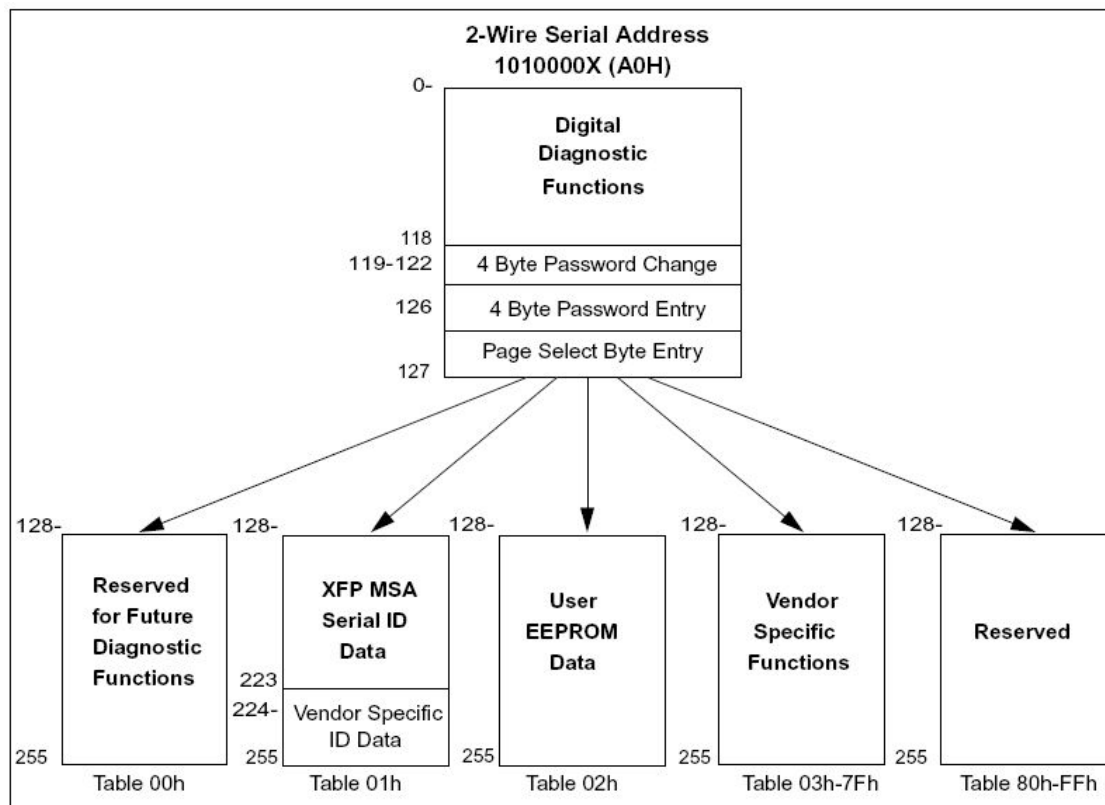
As defined by the XFP MSA 1, TIBTRONIX's XFP transceivers provide digital diagnostic functions via a 2-wire serial interface, which allows real-time access to the following operating parameters:

- ✓ Transceiver temperature
- ✓ Laser bias current
- ✓ Transmitted optical power
- ✓ Received optical power
- ✓ Transceiver supply voltage

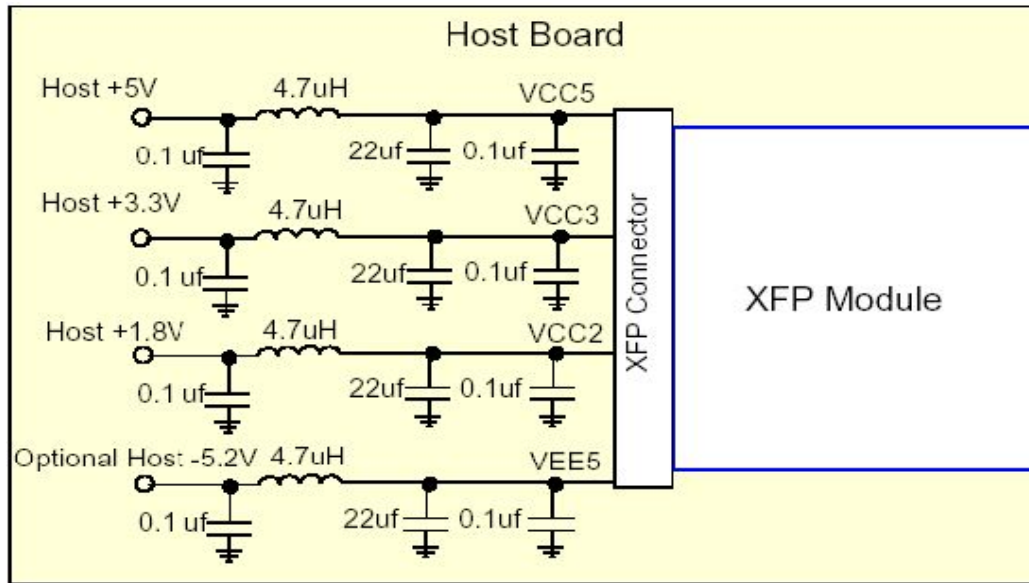
It also provides a sophisticated system of alarm and warning flags, which may be used to alert end-users when particular operating parameters are outside of a factory-set normal range.

The operating and diagnostics information is monitored and reported by a Digital Diagnostics Transceiver Controller (DDTC) inside the transceiver, which is accessed through the 2-wire serial interface. When the serial protocol is activated, the serial clock signal (SCL pin) is generated by the host. The positive edge clocks data into the XFP transceiver into those segments of its memory map that are not write-protected. The negative edge clocks data from the XFP transceiver. The serial data signal (SDA pin) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially. The 2-wire serial interface provides sequential or random access to the 8 bit parameters, addressed from 000h to the maximum address of the memory.

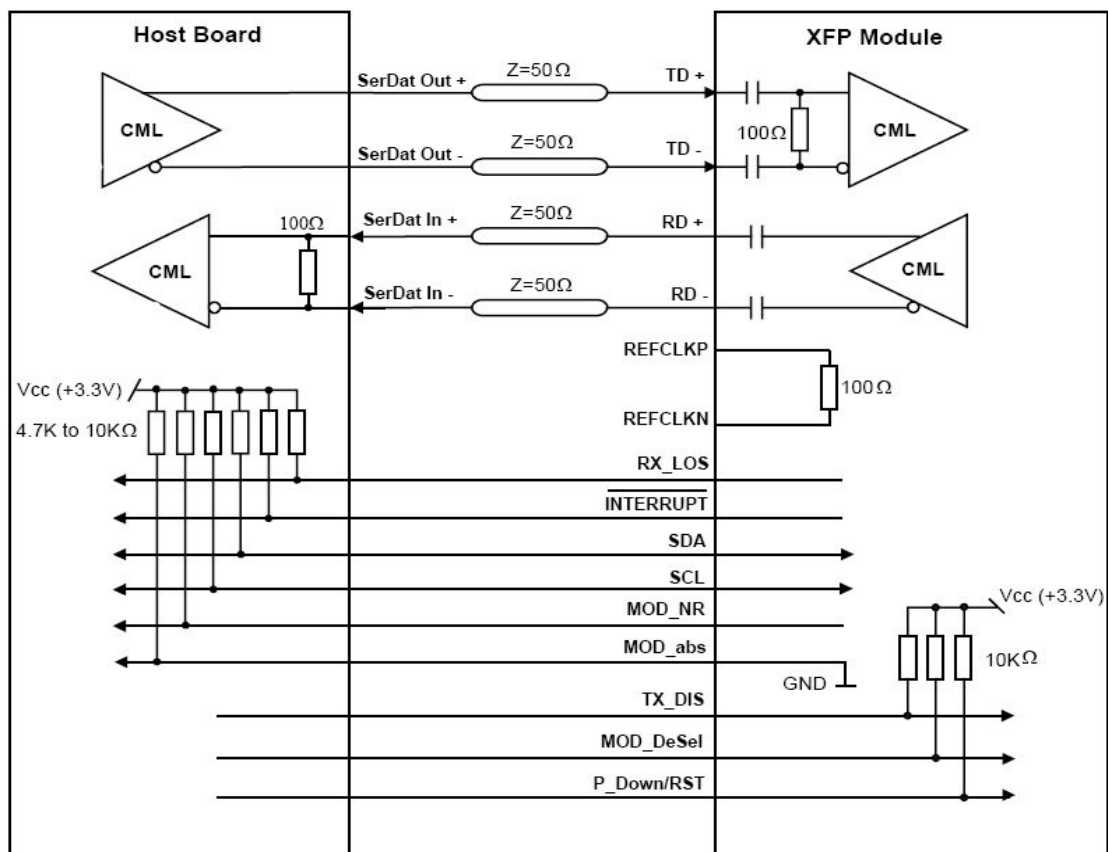
For more detailed information including memory map definitions, please see the XFP MSA Specification.



● Recommended Circuit

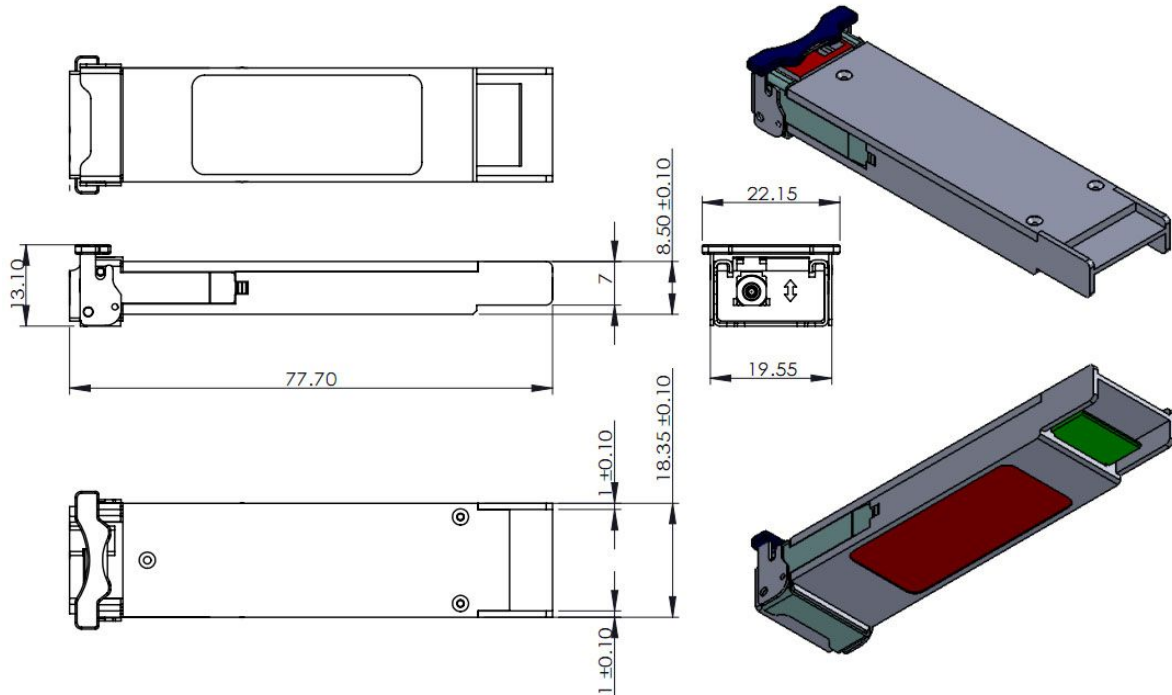


Recommended Host Board Power Supply Circuit



Recommended High-speed Interface Circuit

● Mechanical Dimensions



TIBTRONIX reserves the right to make changes to the products or information contained herein without notice. No liability is assumed as a result of their use or application. No rights under any patent accompany the sale of any such products or information.

Published by Shenzhen TIBTRONIX Technology Co., Ltd.

Copyright © TIBTRONIX

All Rights Reserved